

### EconoPIM2 PIM IGBT Module

$V_{CES}=1200V$ ,  $I_C=75A$ ,  $V_{CE(sat)}=1.75V$

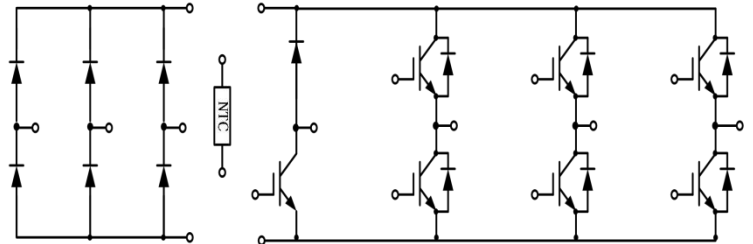
#### Features

- 1200V Trench Gate/Field Termination Process
- Low Switching Losses
- $V_{CE(sat)}$  With Positive Temperature Coefficient
- Integrated NTC Temperature Sensor



#### Applications

- Power Conversion System
- Windgeneratoren
- Static Var Generator



### IGBT, Inverter Maximum Ratings

Parameter	Symbol	Condition	Value	Unit
Collector-emitter voltage	$V_{CES}$	$T_{vj}=25^{\circ}C$ , $V_{GE}=0V$	1200	V
Continuous DC collector current	$I_{C,nom}$	$T_C=100^{\circ}C$ , $T_{vj,max}=175^{\circ}C$	75	A
Repetitive peak collector current	$I_{CRM}$	$t_P=1ms$	150	A
Gate-emitter peak voltage	$V_{GES}$	$T_{vj}=25^{\circ}C$	$\pm 20$	V

### Characteristics Values

Parameter	Symbol	Conditions	Value			Unit	
			Min.	Typ.	Max.		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=75A$ , $V_{GE}=15V$	$T_{vj}=25^{\circ}C$	1.75	2.35	V	
			$T_{vj}=125^{\circ}C$	2.06		V	
			$T_{vj}=150^{\circ}C$	2.14		V	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=2.4mA$ , $V_{CE}=V_{GE}$	$T_{vj}=25^{\circ}C$	5.35	5.85	6.35	V
Gate charge	$Q_G$	$V_{GE}=-15V...+15V$		0.41		$\mu C$	
Integrated gate resistor	$R_{G,int}$	$T_{vj}=25^{\circ}C$		None		$\Omega$	
Input capacitance	$C_{ies}$	$f=100KHz$ , $V_{CE}=25V$ , $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	9.72		nF	
Output capacitance	$C_{oes}$	$f=100KHz$ , $V_{CE}=25V$ , $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	0.86		nF	
Reverse transfer capacitance	$C_{res}$	$f=100KHz$ , $V_{CE}=25V$ , $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	0.05		nF	
Collector-emitter cut-off current	$I_{CES}$	$V_{CE}=1200V$ , $V_{GE}=0V$	$T_{vj}=25^{\circ}C$			1	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0V$ , $V_{GE}=20V$	$T_{vj}=25^{\circ}C$			200	nA

Turn-on delay time	$t_{d\ on}$	$I_C=75A, V_{CE}=600V,$ $V_{GE}=-15V/+15V, R_G=10\Omega,$ Inductive Load	$T_{vj}=25^\circ C$	55	ns
			$T_{vj}=125^\circ C$	53	ns
			$T_{vj}=150^\circ C$	53	ns
Rise time	$t_r$	$I_C=75A, V_{CE}=600V,$ $V_{GE}=-15V/+15V, R_G=10\Omega,$ Inductive Load	$T_{vj}=25^\circ C$	30	ns
			$T_{vj}=125^\circ C$	34	ns
			$T_{vj}=150^\circ C$	36	ns
Turn-off delay time	$t_{d\ off}$	$I_C=75A, V_{CE}=600V,$ $V_{GE}=-15V/+15V, R_G=10\Omega,$ Inductive Load	$T_{vj}=25^\circ C$	214	ns
			$T_{vj}=125^\circ C$	250	ns
			$T_{vj}=150^\circ C$	259	ns
Fall time	$t_f$	$I_C=75A, V_{CE}=600V,$ $V_{GE}=-15V/+15V, R_G=10\Omega,$ Inductive Load	$T_{vj}=25^\circ C$	144	ns
			$T_{vj}=125^\circ C$	228	ns
			$T_{vj}=150^\circ C$	255	ns
Turn-on energy loss per pulse	$E_{on}$	$I_C=75A, V_{CE}=600V,$ $V_{GE}=-15V/+15V, R_G=10\Omega,$ $di/dt=1700A/\mu s (T_{vj}=150^\circ C)$ Inductive Load	$T_{vj}=25^\circ C$	5.41	mJ
			$T_{vj}=125^\circ C$	8.84	mJ
			$T_{vj}=150^\circ C$	9.87	mJ
Turn-off energy loss per pulse	$E_{off}$	$I_C=75A, V_{CE}=600V,$ $V_{GE}=-15V/+15V, R_G=10\Omega,$ $du/dt=5800V/\mu s (T_{vj}=150^\circ C)$ Inductive Load	$T_{vj}=25^\circ C$	3.80	mJ
			$T_{vj}=125^\circ C$	5.53	mJ
			$T_{vj}=150^\circ C$	6.03	mJ
SC data	$I_{SC}$	$V_{GE}\leq 15V, V_{CE}=800V$ $V_{CEmax}=V_{CES}-L_{sCE}\cdot di/dt,$ $t_p\leq 8\mu s,$	$T_{vj}=150^\circ C$	350	A
Thermal resistance, junction to case	$R_{thJC}$	per IGBT		0.456	K/W
Temperature under switching conditions	$T_{vj\ op}$		-40	150	$^\circ C$

### Diode, Inverter Maximum Ratings

Parameter	Symbol	Conditions	Value	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj}=25^\circ C$	1200	V	
Continuous forward current	$I_F$		75	A	
Repetitive peak forward current	$I_{FRM}$	$t_p=1ms$	150	A	
$I^2t$ -value	$I^2t$	$t_p=10ms, \sin 180^\circ$	$T_{vj}=125^\circ C$	960	$A^2s$

### Characteristics Values

Parameter	Symbol	Conditions	Values			Units
			Min.	Typ.	Max.	
Forward voltage	$V_F$	$I_F=75A, V_{GE}=0V$	$T_{vj}=25^\circ C$	2.15	2.6	V
			$T_{vj}=125^\circ C$	1.8		V
			$T_{vj}=150^\circ C$	1.75		V
Peak reverse recovery current	$I_{rr}$	$I_F=75A,$ $V_R=600V,$ $V_{GE}=-15V,$ $-di_F/dt=2600A/\mu s$ ( $T_{vj}=150^\circ C$ )	$T_{vj}=25^\circ C$	93		A
			$T_{vj}=125^\circ C$	127		A
			$T_{vj}=150^\circ C$	135		A

Recovered charge	$Q_{rr}$	$I_F=75A,$ $V_R=600V,$ $V_{GE}=-15V,$ $-diF/dt=2600A/\mu s$ ( $T_{vj}=150^\circ C$ )	$T_{vj}=25^\circ C$		7.9		$\mu C$
			$T_{vj}=125^\circ C$		17.8		$\mu C$
			$T_{vj}=150^\circ C$		21.2		$\mu C$
Reverse recovery energy	$E_{rec}$		$T_{vj}=25^\circ C$		2.84		mJ
			$T_{vj}=125^\circ C$		6.58		mJ
			$T_{vj}=150^\circ C$		7.90		mJ
Thermal resistance, junction to case	$R_{thJC}$	per FRD			0.547		K/W
Temperature under switching conditions	$T_{vj op}$			-40		150	$^\circ C$

### Diode, Rectifier Maximum Ratings

Parameter	Symbol	Conditions	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj}=25^\circ C, I_{RRM}=0.05mA$	1600	V
Maximum average forward current	$I_{F(AV)}$	$T_s=80^\circ C, T_{vj}=25^\circ C$	75	A
Surge forward current	$I_{FSM}$	$t_p=10ms, \sin 180^\circ$	$T_{vj}=25^\circ C$ 720	A
$I^2t$ -value	$I^2t$	$t_p=10ms, \sin 180^\circ$	$T_{vj}=125^\circ C$ 2590	$A^2s$

### Characteristics Values

Parameter	Symbol	Conditions	Values			Units
			Min.	Typ.	Max.	
Forward voltage	$V_F$	$I_F=75A$	$T_{vj}=25^\circ C$	1.18	1.40	V
Reverse current	$I_R$	$V_R=V_{RRM}$	$T_{vj}=25^\circ C$		1	mA
Thermal resistance, junction to case	$R_{thJC}$			0.393		K/W
Temperature under switching conditions	$T_{vj op}$			-40	150	$^\circ C$

### IGBT, Brake-Chopper Maximum Ratings

Parameter	Symbol	Condition	Value	Unit
Collector-emitter voltage	$V_{CES}$	$T_{vj}=25^\circ C, V_{GE}=0V$	1200	V
Continuous DC collector current	$I_{C nom}$	$T_C=100^\circ C, T_{vj max}=175^\circ C$	40	A
Repetitive peak collector current	$I_{CRM}$	$t_p=1ms$	80	A
Gate-emitter peak voltage	$V_{GE}$	$T_{vj}=25^\circ C$	$\pm 20$	V

### Characteristics Values

Parameter	Symbol	Conditions	Value			Unit	
			Min.	Typ.	Max.		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=40A, V_{GE}=15V$	$T_{vj}=25^\circ C$	1.78	2.4	V	
			$T_{vj}=125^\circ C$	2.09		V	
			$T_{vj}=150^\circ C$	2.16		V	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=1.5mA, V_{CE}=V_{GE}$	$T_{vj}=25^\circ C$	5.1	5.7	6.3	V
Gate charge	$Q_G$	$V_{GE}=-15V...+15V$		0.33		$\mu C$	

Integrated gate resistor	$R_{G\text{ int}}$			None		$\Omega$
Input capacitance	$C_{ies}$	$f=100\text{KHz}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$	2.8		nF
Output capacitance	$C_{oes}$	$f=100\text{KHz}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$	0.45		nF
Reverse transfer capacitance	$C_{res}$	$f=100\text{KHz}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$	0.13		nF
Collector-emitter cut-off current	$I_{CES}$	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$		1	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$	$T_{vj}=25^\circ\text{C}$		200	nA
Turn-on delay time	$t_{d\text{ on}}$	$I_C=40\text{A}, V_{CE}=600\text{V}, V_{GE}=-15\text{V}/+15\text{V}, R_G=20\Omega,$ Inductive Load	$T_{vj}=25^\circ\text{C}$	47		ns
			$T_{vj}=125^\circ\text{C}$	39		ns
			$T_{vj}=150^\circ\text{C}$	39		ns
Rise time	$t_r$	$I_C=40\text{A}, V_{CE}=600\text{V}, V_{GE}=-15\text{V}/+15\text{V}, R_G=20\Omega,$ Inductive Load	$T_{vj}=25^\circ\text{C}$	45		ns
			$T_{vj}=125^\circ\text{C}$	47		ns
			$T_{vj}=150^\circ\text{C}$	48		ns
Turn-off delay time	$t_{d\text{ off}}$	$I_C=40\text{A}, V_{CE}=600\text{V}, V_{GE}=-15\text{V}/+15\text{V}, R_G=20\Omega,$ Inductive Load	$T_{vj}=25^\circ\text{C}$	258		ns
			$T_{vj}=125^\circ\text{C}$	315		ns
			$T_{vj}=150^\circ\text{C}$	331		ns
Fall time	$t_f$	$I_C=40\text{A}, V_{CE}=600\text{V}, V_{GE}=-15\text{V}/+15\text{V}, R_G=20\Omega,$ Inductive Load	$T_{vj}=25^\circ\text{C}$	155		ns
			$T_{vj}=125^\circ\text{C}$	250		ns
			$T_{vj}=150^\circ\text{C}$	260		ns
Turn-on energy loss per pulse	$E_{on}$	$I_C=40\text{A}, V_{CE}=600\text{V}, V_{GE}=-15\text{V}/+15\text{V}, R_G=20\Omega,$ $di/dt=2100\text{A}/\mu\text{s} (T_{vj}=150^\circ\text{C})$ Inductive Load	$T_{vj}=25^\circ\text{C}$	4.57		mJ
			$T_{vj}=125^\circ\text{C}$	6.50		mJ
			$T_{vj}=150^\circ\text{C}$	7.19		mJ
Turn-off energy loss per pulse	$E_{off}$	$I_C=40\text{A}, V_{CE}=600\text{V}, V_{GE}=-15\text{V}/+15\text{V}, R_G=20\Omega,$ $du/dt=4200\text{V}/\mu\text{s} (T_{vj}=150^\circ\text{C})$ Inductive Load	$T_{vj}=25^\circ\text{C}$	2.15		mJ
			$T_{vj}=125^\circ\text{C}$	3.32		mJ
			$T_{vj}=150^\circ\text{C}$	3.64		mJ
SC data	$I_{SC}$	$V_{GE}\leq 15\text{V}, V_{CE}=800\text{V}$ $V_{CE\text{ max}}=V_{CES}-L_{sCE}\cdot di/dt,$ $t_p\leq 8\mu\text{s},$	$T_{vj}=150^\circ\text{C}$	220		A
Thermal resistance, junction to case	$R_{thJC}$			0.509		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$			-40	150	$^\circ\text{C}$

### Diode, Brake-Chopper Maximum Ratings

Parameter	Symbol	Conditions	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj}=25^\circ\text{C}$	1200	V
Continuous forward current	$I_{FN}$		40	A
Repetitive peak forward current	$I_{FRM}$	$t_p=1\text{ms}$	80	A
$I^2t$ -value	$I^2t$	$t_p=10\text{ms}, \sin 180^\circ$	$T_{vj}=125^\circ\text{C}$	310 $\text{A}^2\text{s}$

**Characteristics Values**

Parameter	Symbol	Conditions	Value			Units
			Min.	Typ.	Max.	
Forward voltage	$V_F$	$I_F=40A, V_{GE}=0V$	$T_{vj}=25^{\circ}C$	1.95	2.5	V
			$T_{vj}=125^{\circ}C$	1.71		V
			$T_{vj}=150^{\circ}C$	1.65		V
Peak reverse recovery current	$I_{rr}$		$T_{vj}=25^{\circ}C$	27		A
			$T_{vj}=125^{\circ}C$	40		A
			$T_{vj}=150^{\circ}C$	44		A
Recovered charge	$Q_{rr}$	$I_F=40A,$ $V_R=600V,$ $V_{GE}=-15V,$ $-diF/dt=800A/\mu s$ ( $T_{vj}=150^{\circ}C$ )	$T_{vj}=25^{\circ}C$	3.6		$\mu C$
			$T_{vj}=125^{\circ}C$	8.4		$\mu C$
			$T_{vj}=150^{\circ}C$	10.2		$\mu C$
Reverse recovery energy	$E_{rec}$		$T_{vj}=25^{\circ}C$	1.18		mJ
			$T_{vj}=125^{\circ}C$	2.16		mJ
			$T_{vj}=150^{\circ}C$	2.55		mJ
Thermal resistance, junction to case	$R_{thJC}$			0.836		K/W
Temperature under switching conditions	$T_{vj op}$		-40		150	$^{\circ}C$

**NTC-Thermistor**  
**Characteristics Values**

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
Rated resistance	$R_{25}$	$T_C=25^{\circ}C, \pm 5\%$		5.0		k $\Omega$
$\Delta R/R$			-5		-5	%
B-value	$B_{25/50}$	$\pm 3\%$		3375		K
B-value	$B_{25/100}$	$\pm 3\%$		3433		K

**Module**  
**Characteristics Values**

Parameter	Symbol	Conditions	Value			Units
			Min.	Typ.	Max.	
Isolation test voltage	$V_{ISOL}$	RMS, $f=50Hz, t=1min$		2.5		kV
Internal isolation	-		$Al_2O_3$			-
Storage temperature	$T_{stg}$		-40		125	$^{\circ}C$
Mounting torque for module mounting	M		3	-	6	N·m
Weight	G			180		g

## Typical Characteristics

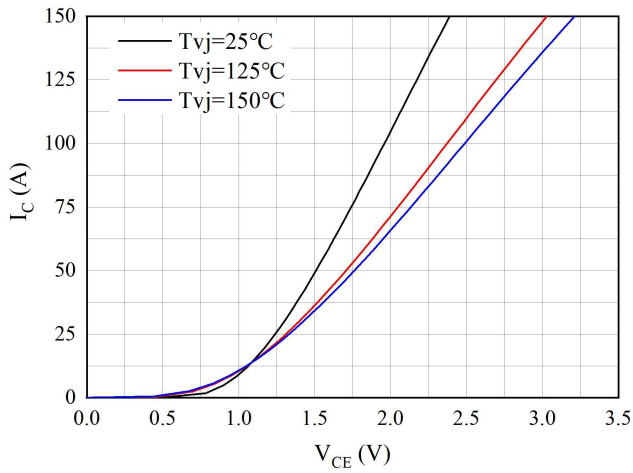


Fig 1. Typical output characteristics ( $V_{GE}=15V$ )

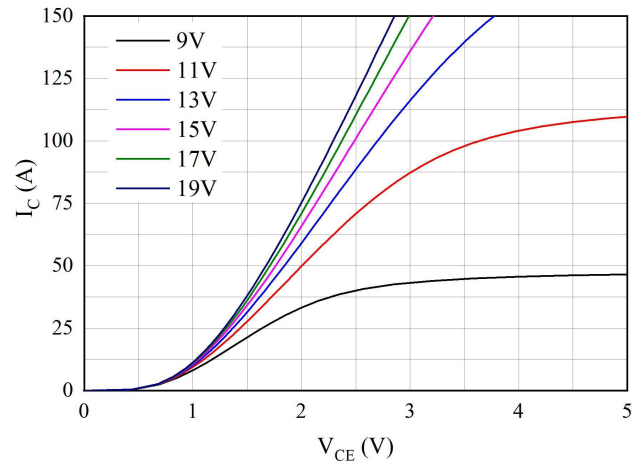


Fig 2. Typical output characteristics ( $T_{vj}=150^{\circ}C$ )

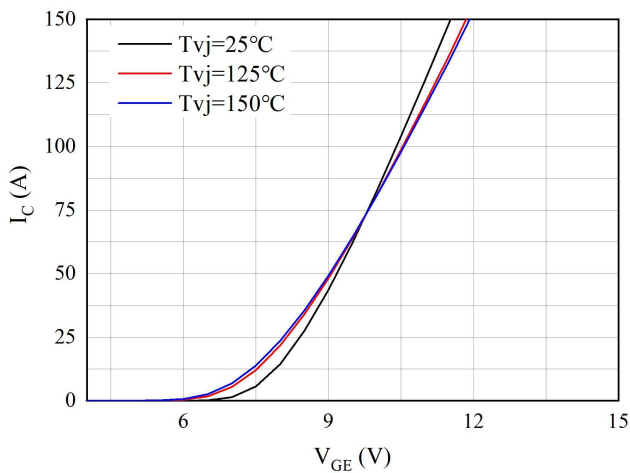


Fig 3. Typical transfer characteristics ( $V_{CE}=20V$ )

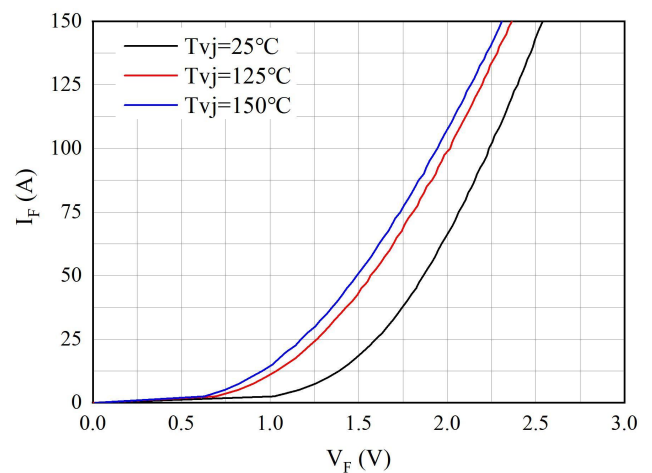


Fig 4. Forward characteristics of Diode

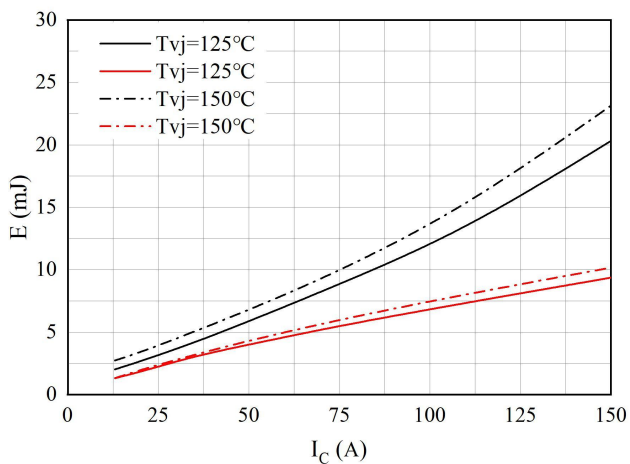


Fig 5. Switching losses of IGBT, Inverter  
 $V_{GE}=\pm 15V$ ,  $R_{Gon}=R_{Goff}=10\Omega$ ,  $V_{CE}=600V$

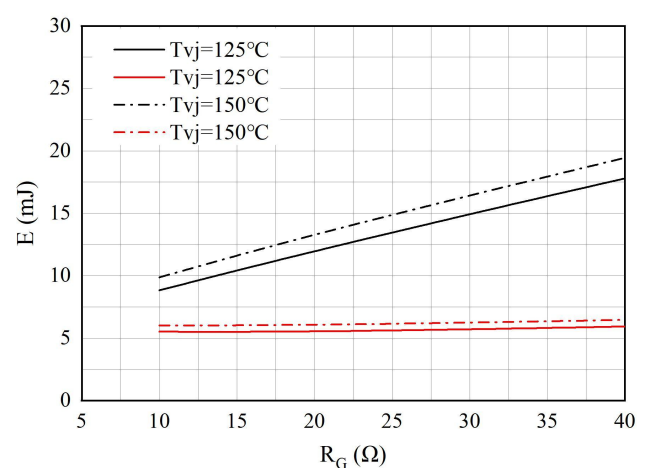
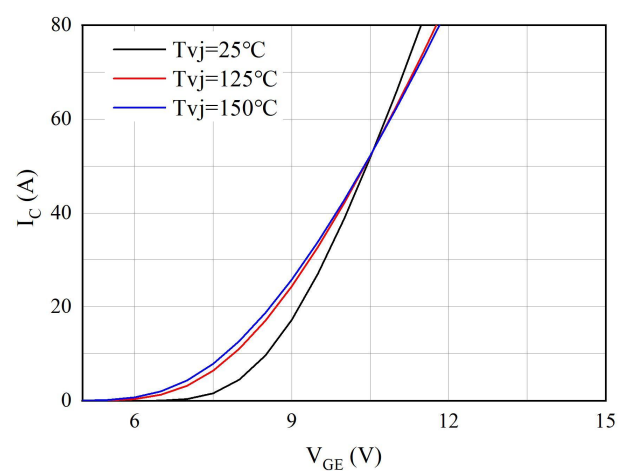
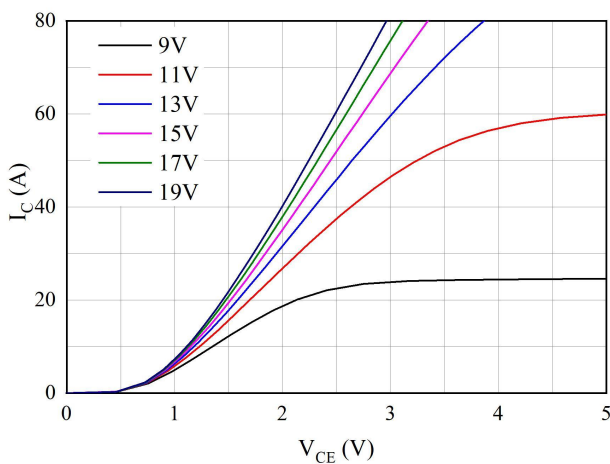
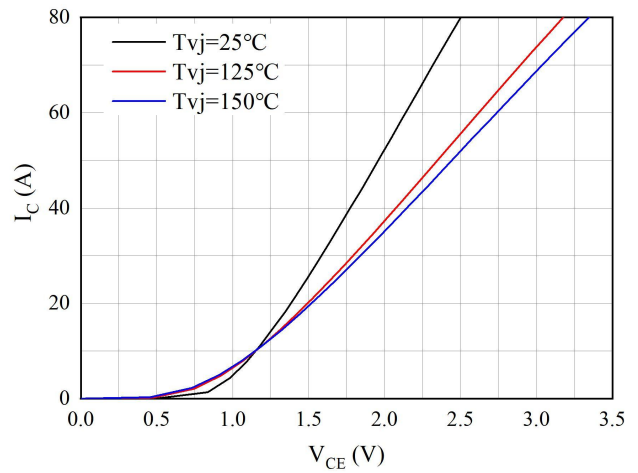
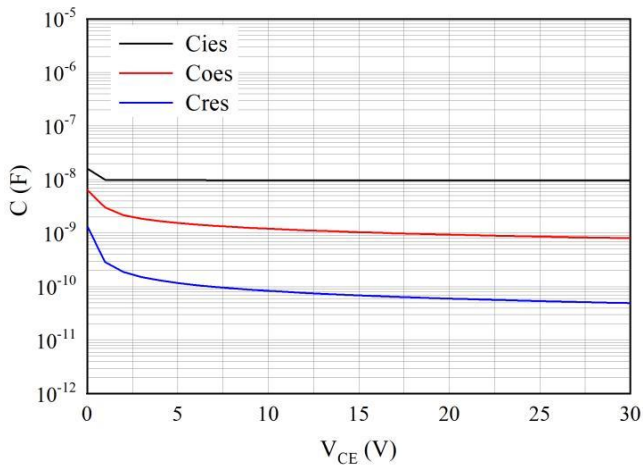
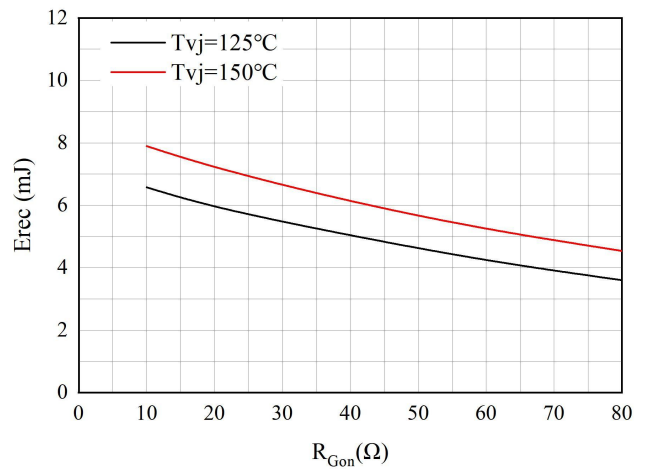
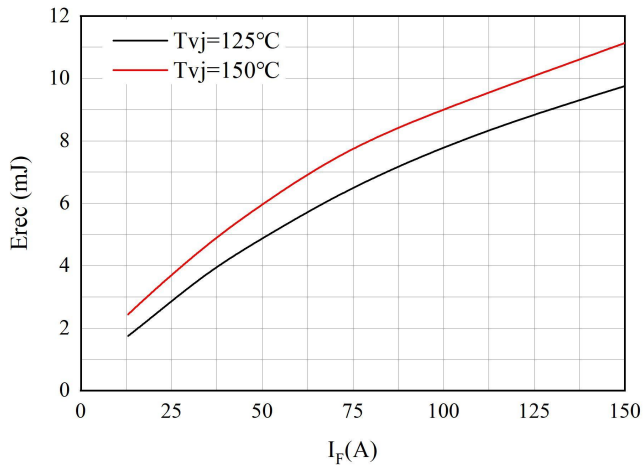


Fig 6. Switching losses of IGBT, Inverter  
 $V_{GE}=\pm 15V$ ,  $I_C=75A$ ,  $V_{CE}=600V$



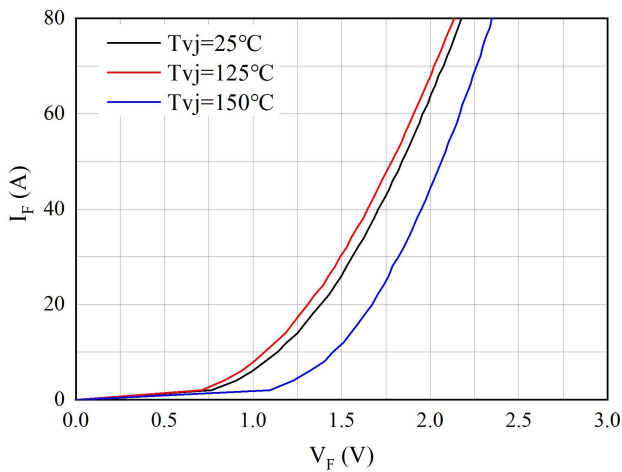


Fig 13. Forward characteristic of Diode, Brake-Chopper

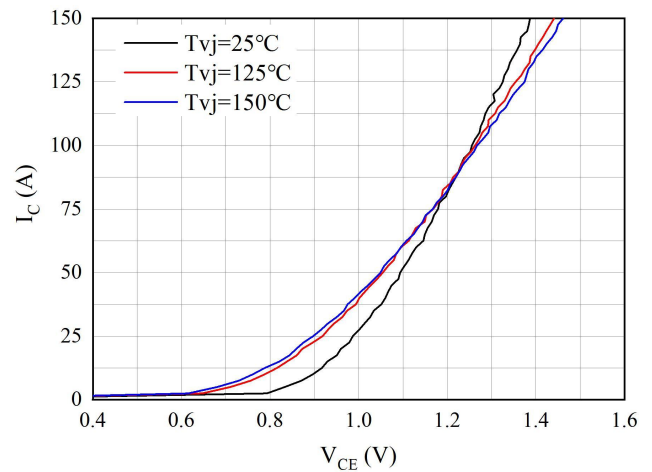


Fig 14. Forward characteristic of Diode, Rectifier

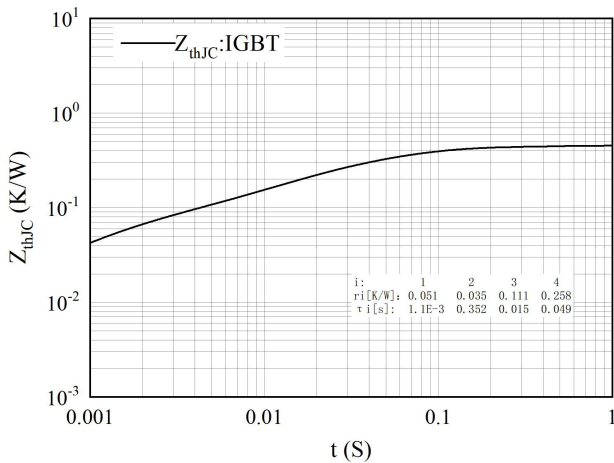


Fig 15. Transient thermal impedance IGBT, Inverter  $Z_{thJC}=f(t)$

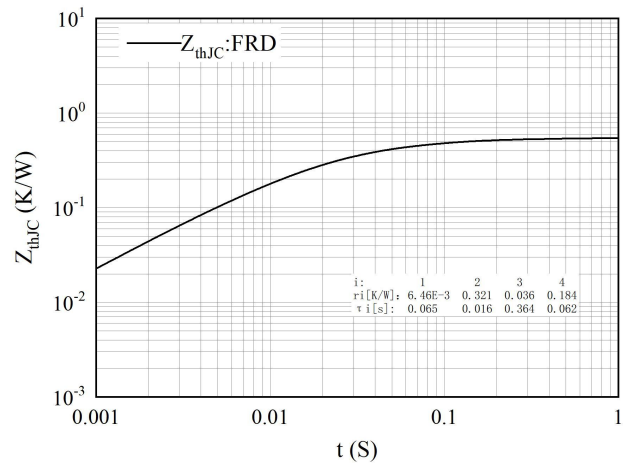


Fig 16. Transient thermal impedance FRD, Inverter  $Z_{thJC}=f(t)$

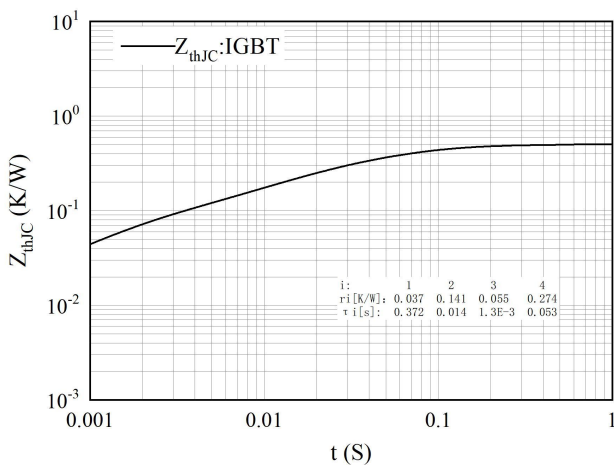


Fig 17. Transient thermal impedance IGBT, Inverter  $Z_{thJC}=f(t)$ , Brake-Chopper

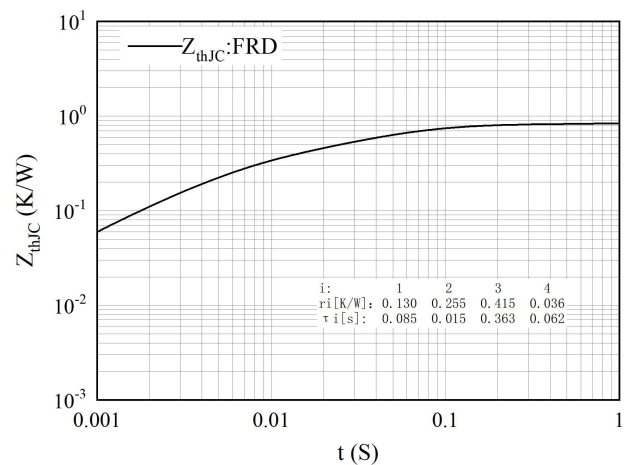


Fig 18. Transient thermal impedance FRD, Inverter  $Z_{thJC}=f(t)$ , Brake-Chopper

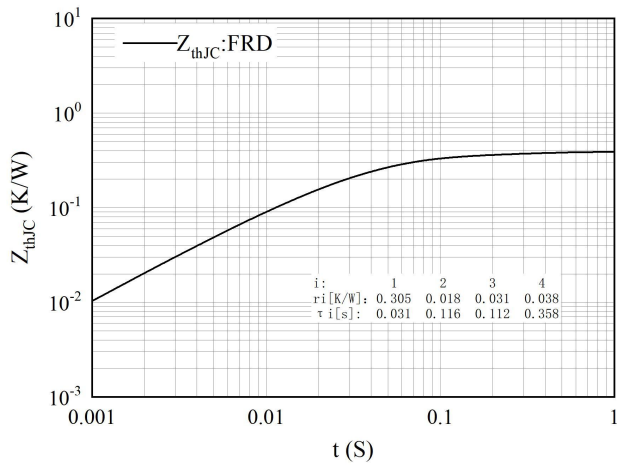


Fig 19. Transient thermal impedance Diode,  
 $Z_{thJC} = f(t)$

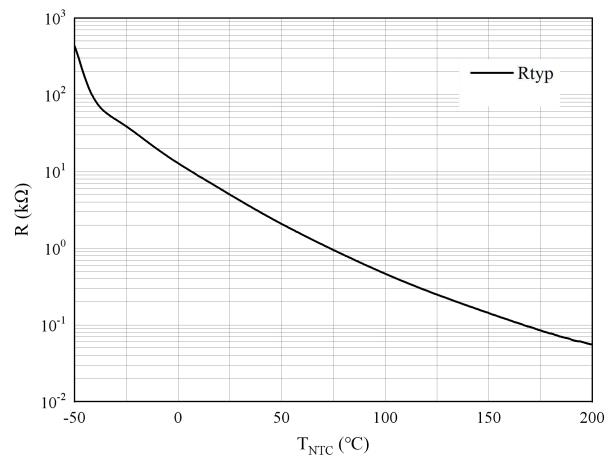
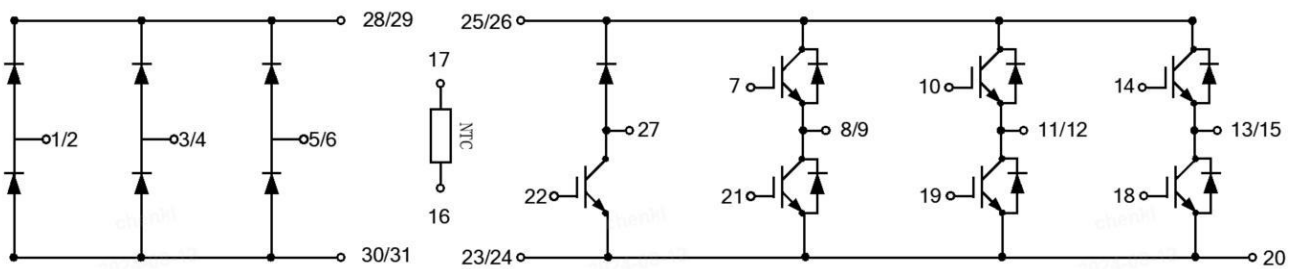
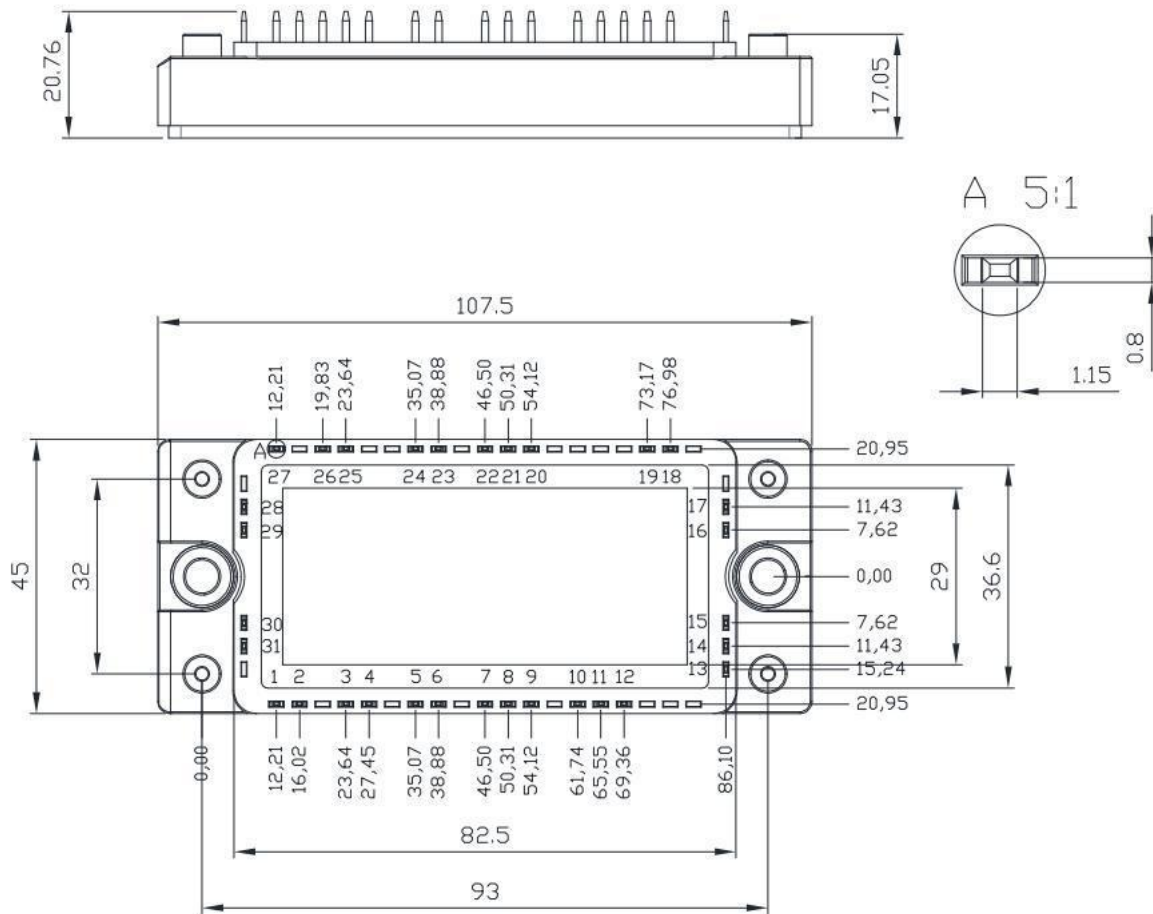


Fig 20. NTC-Themistor-temperature characteristic

### Circuit Diagram



**Package Outlines (Unit:mm)**



**\*Important Usage Information and Disclaimer**

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